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PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Akihiro MURATA

Group Art Unit: 2814

Application No.: 09/245,288

Examiner: D. Graybill

Filed: February 5, 1999

Docket No.: 101937

For: SEMICONDUCTOR APPARATUS SUBSTRATE, SEMICONDUCTOR APPARATUS, AND METHOD OF MANUFACTURING THEREOF AND ELECTRONIC APPARATUS

AMENDMENT UNDER 37 C.F.R. §1.111

Director of the U.S. Patent and Trademark Office  
Washington, D.C. 20231

Sir:

In reply to the Office Action mailed March 19, 2002, please amend the above identified Application as follows:

IN THE CLAIMS:

Please cancel claims 2, 8, 11 and 19-25 without prejudice to or disclaimer of the subject matter contained therein.

Please replace claims 1 and 7 as follows:

1. (Twice Amended) A substrate for semiconductor apparatus, comprising:
- a substrate main body having a delineated mounting surface for mounting the semiconductor device;
- a plurality of leads formed on the mounting surface, the plurality of lead radially extending from a peripheral area toward a central area of the substrate main body; and
- a plurality of conduction sections each defining at least part of an external terminal with substantially rectangular contour lines, the conduction sections being electrically